



Bulletin I27104 rev. A 09/97

IRK.F72.. SERIES

FAST THYRISTOR/DIODE and THYRISTOR/THYRISTOR

INT-A-pak™ Power Modules

71 A

Features

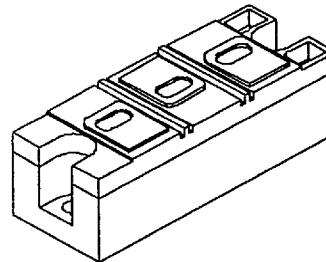
- Fast turn-off thyristor
- Fast recovery diode
- High surge capability
- Electrically isolated baseplate
- 3000 V_{RMS} isolating voltage
- Industrial standard package
- UL E78996 approved

Description

These series of INT-A-pak modules are intended for applications such as self-commutated inverters, DC choppers, electronic welders, induction heating and others where fast switching characteristics are required.

Major Ratings and Characteristics

Parameters	IRK.F72..	Units
I _{T(AV)}	71	A
@ T _C	90	°C
I _{T(RMS)}	158	A
I _{TSM}	2100	A
@ 50Hz	2200	A
I ² t	21.6	KA ² s
@ 50Hz	19.8	KA ² s
I ² vt	216	KA ² /s
t _q	20 and 25	μs
t _{rr}	2	μs
V _{DRM/V_{RMM}}	upto 1200	V
T _J range	-40 to 125	°C



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International
IR Rectifier

ELECTRICAL SPECIFICATIONS

Voltage Ratings

Type number	Voltage Code	V_{RRM}/V_{DRM} , maximum repetitive peak reverse voltage V	V_{RSM} , maximum non-repetitive peak rev. voltage V	I_{RRM}/I_{DRM} max. @ $T_J = 125^\circ C$ mA
IRK.F72..	08	800	800	30
	12	1200	1200	

Current Carrying Capacity

Frequency f				Units
50Hz	140	230	220	345
400Hz	170	280	250	406
2500Hz	135	210	210	330
5000Hz	115	180	205	310
10000Hz	85	140	165	235
Recovery voltage V_r	50	50	50	50
Voltage before turn-on V_d	80% V_{DRM}	80% V_{DRM}	80% V_{DRM}	V
Rise of on-state current dI/dt	50	50	-	A/ μ s
Case temperature	90	60	90	60
Equivalent values for RC circuit	22Ω/0.15µF	22Ω/0.15µF	22Ω/0.15µF	°C

On-state Conduction

Parameter	IRK.F72..	Units	Conditions
$I_{T(AV)}$ Maximum average on-state current @ Case temperature	71	A	180° conduction, half sine wave
	90	°C	
$I_{T(RMS)}$ Maximum RMS current	158	A	$T_c = 90^\circ C$, as AC switch
	2100	A	
	2200		
	1750		
	1830		
P_t Maximum P_t for fusing	21.6	KA·s	Initial $T_J = 125^\circ C$
	19.8		
	15.3		
	14.0		
	216	KA ² /s	
V_{TR01} Low level value of threshold voltage	1.28	V	(16.7% $\times \pi \times I_{T(AV)} < I < \pi \times I_{T(AV)}$), $T_J = T_J$ max.
	1.32		
r_{11} Low level value of on-state slope resistance	3.20	mW	(16.7% $\times \pi \times I_{T(AV)} < I < \pi \times I_{T(AV)}$), $T_J = T_J$ max.
	3.00		
V_{TM} Maximum on-state voltage drop	2.40	V	$I_{pk} = 350A$, $T_J = T_J$ max., $t_p = 10ms$ sine pulse
	600	mA	
I_h Maximum holding current	600	mA	$T_J = 25^\circ C$, $V_A = 12V$, $R_a = 6\Omega$, $I_g = 1A$
I_L Typical latching current	1000	mA	

Switching

Parameter	IRK.F72..		Units	Conditions
di/dt Maximum non-repetitive rate of rise	800		A/μs	Gate drive 20V, 20Ω, tr ≤ 1ms, V _G = 80% V _{DRM} , T _J = 125°C
t _r Maximum recovery time	2		μs	I _{TM} = 350A, di/dt = -25A/μs, V _R = 50V, T _J = 25°C
t _q Maximum turn-off time	K 20	J 25	μs	I _{TM} = 350A, T _J = 125°C, di/dt = -25A/μs, V _R = 50V, dv/dt = 400V/μs linear to 80% V _{DRM}

Blocking

Parameter	IRK.F72..		Units	Conditions
dv/dt Maximum critical rate of rise of off-state voltage	1000		V/μs	T _J = 125°C., exponential to = 67% V _{DRM}
V _{INS} RMS isolation voltage	3000		V	50 Hz, circuit to base, T _J = 25°C, t = 1 s
I _{RRM} Maximum peak reverse and off-state leakage current	30		mA	T _J = 125°C, rated V _{DRM} /V _{RRM} applied

Triggering

Parameter	IRK.F72..		Units	Conditions
P _{GM} Maximum peak gate power	60		W	f = 50 Hz, d% = 50
P _{G(AV)} Maximum peak average gate power	10		W	T _J = 125°C, f = 50Hz, d% = 50
I _{GM} Maximum peak positive gate current	10		A	T _J = 125°C, t _p ≤ 5ms
-V _{GM} Maximum peak negative gate voltage	5		V	
I _{GT} Max. DC gate current required to trigger	200		mA	T _J = 25°C, V _{ak} 12V, R _a = 6
V _{GT} DC gate voltage required to trigger	3		V	
I _{GD} DC gate current not to trigger	20		mA	T _J = 125°C, rated V _{DRM} applied
V _{GD} DC gate voltage not to trigger	0.25		V	

Thermal and Mechanical Specifications

Parameter	IRK.F72..		Units	Conditions
T _J Max. junction operating temperature range	-40 to 125		°C	
T _{stg} Max. storage temperature range	-40 to 150			
R _{thJC} Max. thermal resistance, junction to case	0.17		K/W	Per junction, DC operation
R _{thChs} Max. thermal resistance, case to heatsink	0.035		K/W	Mounting surface flat and greased Per module
T Mounting torque ± 10%	IAP to heatsink busbar to IAP	4 - 6 (35 - 53)	Nm (lb*in)	A mounting compound is recommended. The torque should be rechecked after a period of 3 hours to allow for the spread of the compound. Use of cable lugs is not recommended, busbars should be used and restrained during tightening. Threads must be lubricated with a compound
wt Approximate weight		500 (17.8)	g (oz)	

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International
 **Rectifier**
 ΔR_{thJC} Conduction(The following table shows the increment of thermal resistance R_{thJC} when devices operate at different conduction angles than DC)

Conduction angle	Sinusoidal conduction	Rectangular conduction	Units	Conditions
180°	0.016	0.011	K/W $T_J = 125^\circ\text{C}$	
120°	0.019	0.020		
90°	0.024	0.026		
60°	0.035	0.037		
30°	0.060	0.060		

Ordering Information Table

Device Code								
IRK	T	F	7	2	-	12	H	K N
①	②	③	④	⑤	⑥	⑦	⑧	⑨
1 - Module type								
2 - Circuit configuration								
3 - Fast SCR								
4 - Current rating: $I_{T(AV)} \times 10$ rounded								
5 - 1 = option with spacers and longer terminal screws								
2 = option with standard terminal screws								
6 - Voltage code: Code $\times 100 = V_{RRM}$ (See Voltage Ratings Table)								
7 - dv/dt code: H $\leq 400\text{V}/\mu\text{s}$								
8 - t_q code: K $\leq 20\mu\text{s}$ J $\leq 25\mu\text{s}$								
9 - None = Standard devices								
N = Aluminum nitride substrate								

NOTE: To order the Optional Hardware see Bulletin I27900

Outline Table

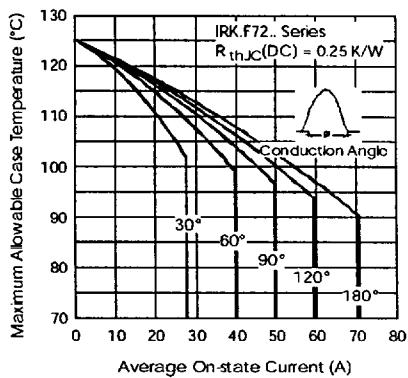
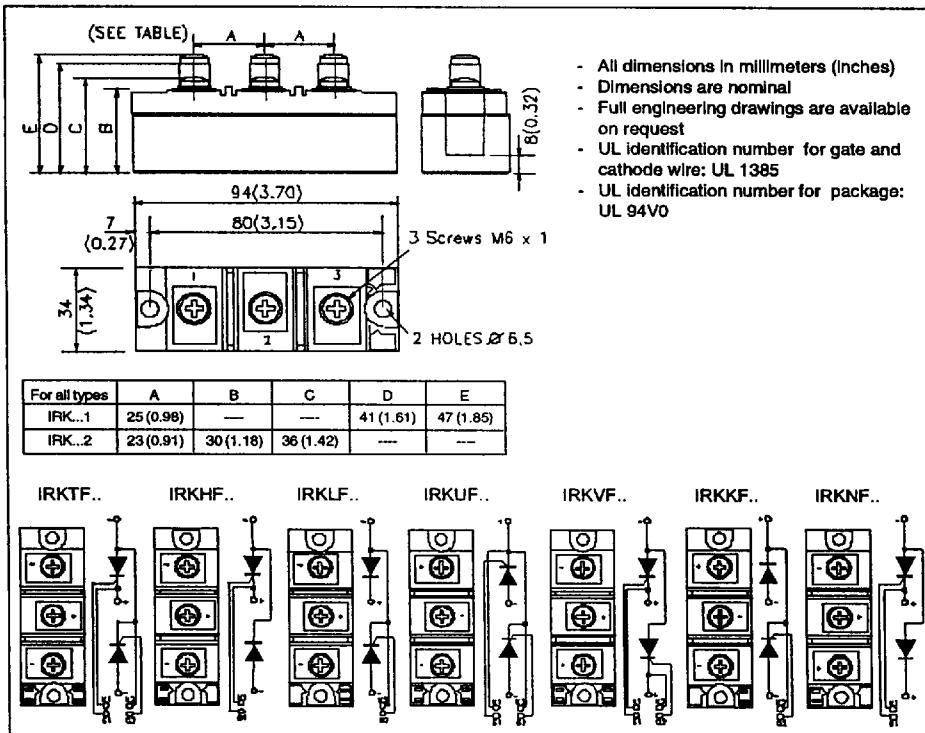


Fig. 1 - Current Ratings Characteristics

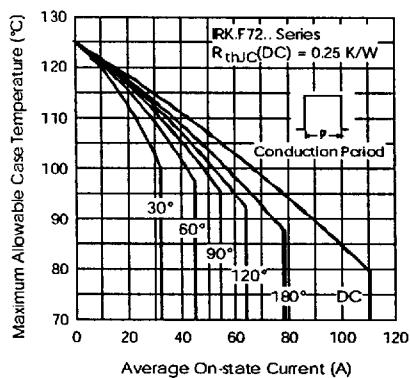


Fig. 2 - Current Ratings Characteristics

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International
IR Rectifier

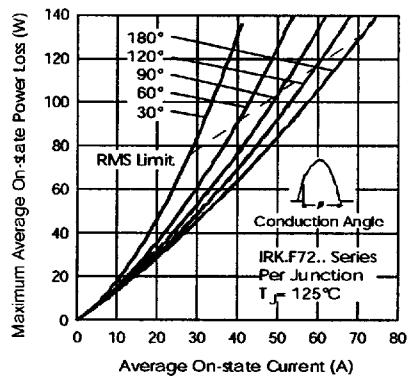


Fig. 3 - On-state Power Loss Characteristics

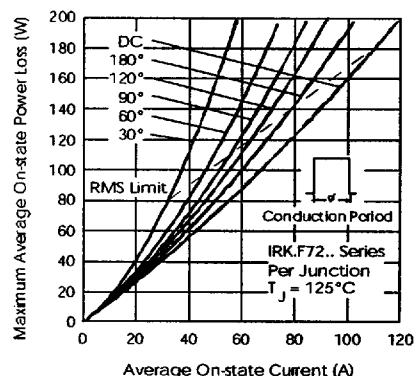


Fig. 4 - On-state Power Loss Characteristics

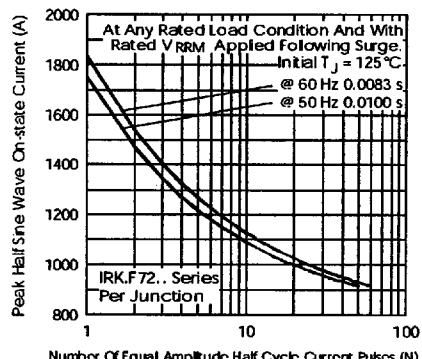


Fig. 5 - Maximum Non-Repetitive Surge Current

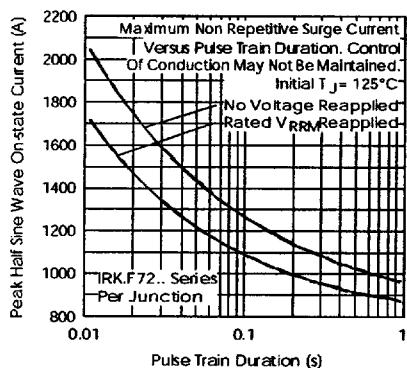


Fig. 6 - Maximum Non-Repetitive Surge Current

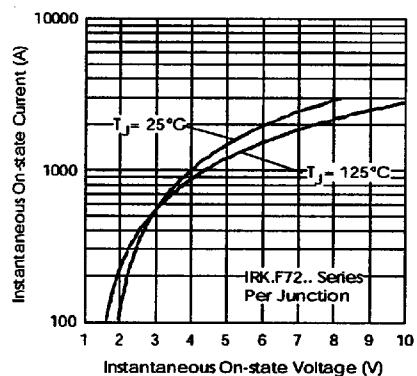


Fig. 7 - On-state Voltage Drop Characteristics

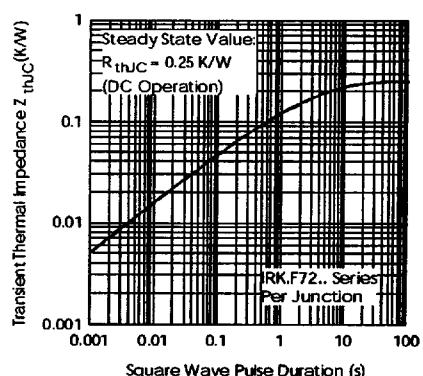


Fig. 8 - Thermal Impedance Z_{thJC} Characteristic

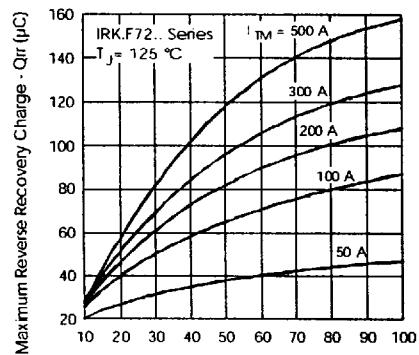


Fig. 9 - Reverse Recovery Charge Characteristic

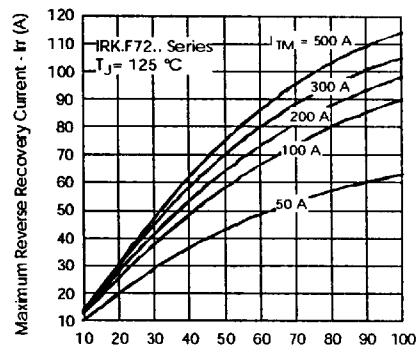


Fig. 10 - Reverse Recovery Current Characteristic

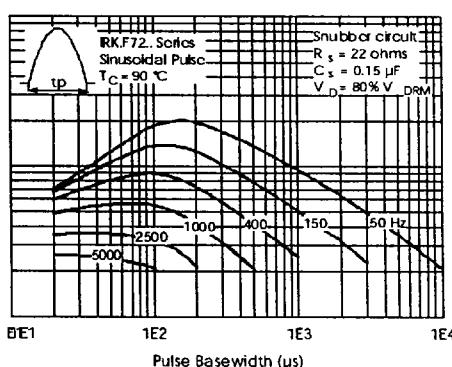
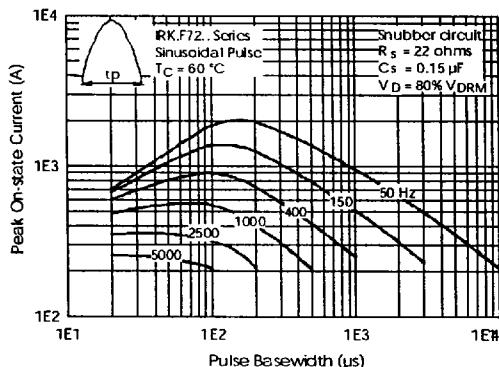


Fig. 11 - Frequency Characteristics

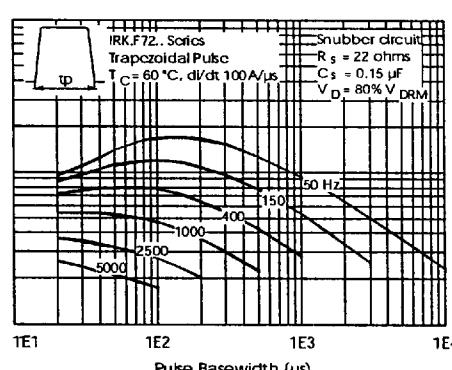
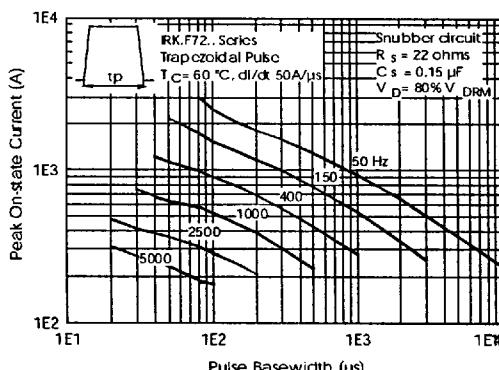


Fig. 12 - Frequency Characteristics

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International
I²R Rectifier

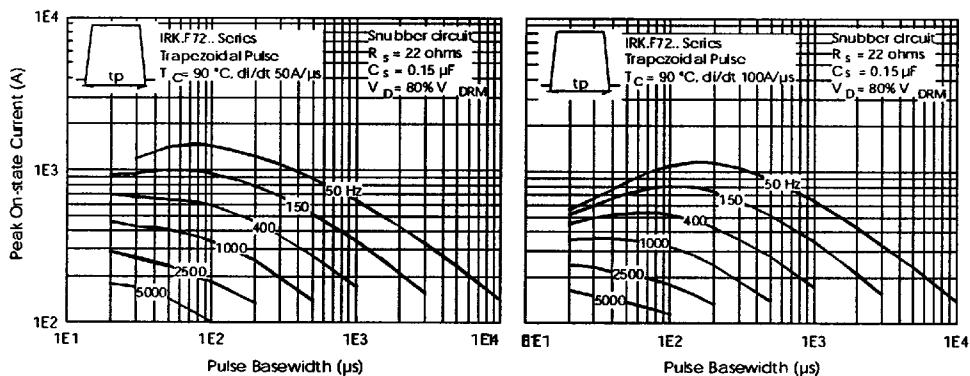


Fig. 13 - Frequency Characteristics

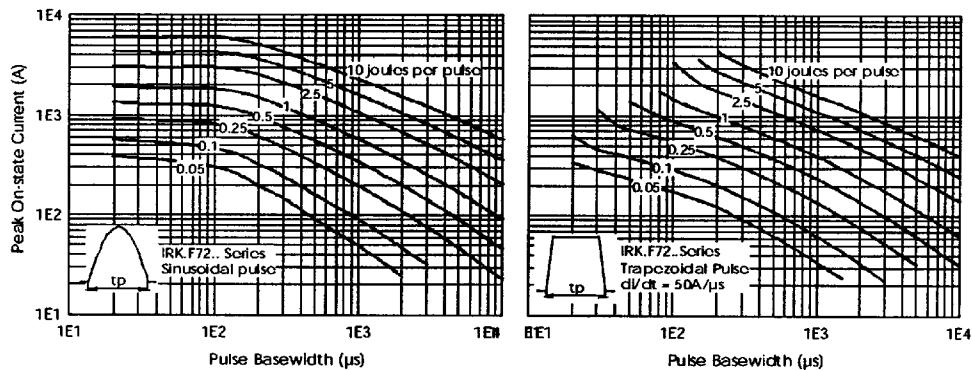


Fig. 14 - Maximum On-state Energy Power Loss Characteristics

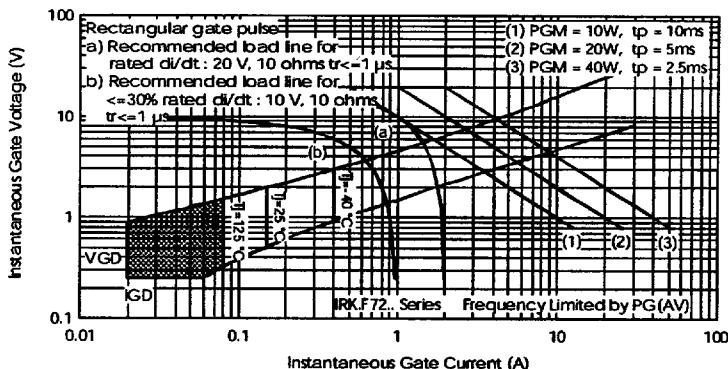


Fig. 15 - Gate Characteristics